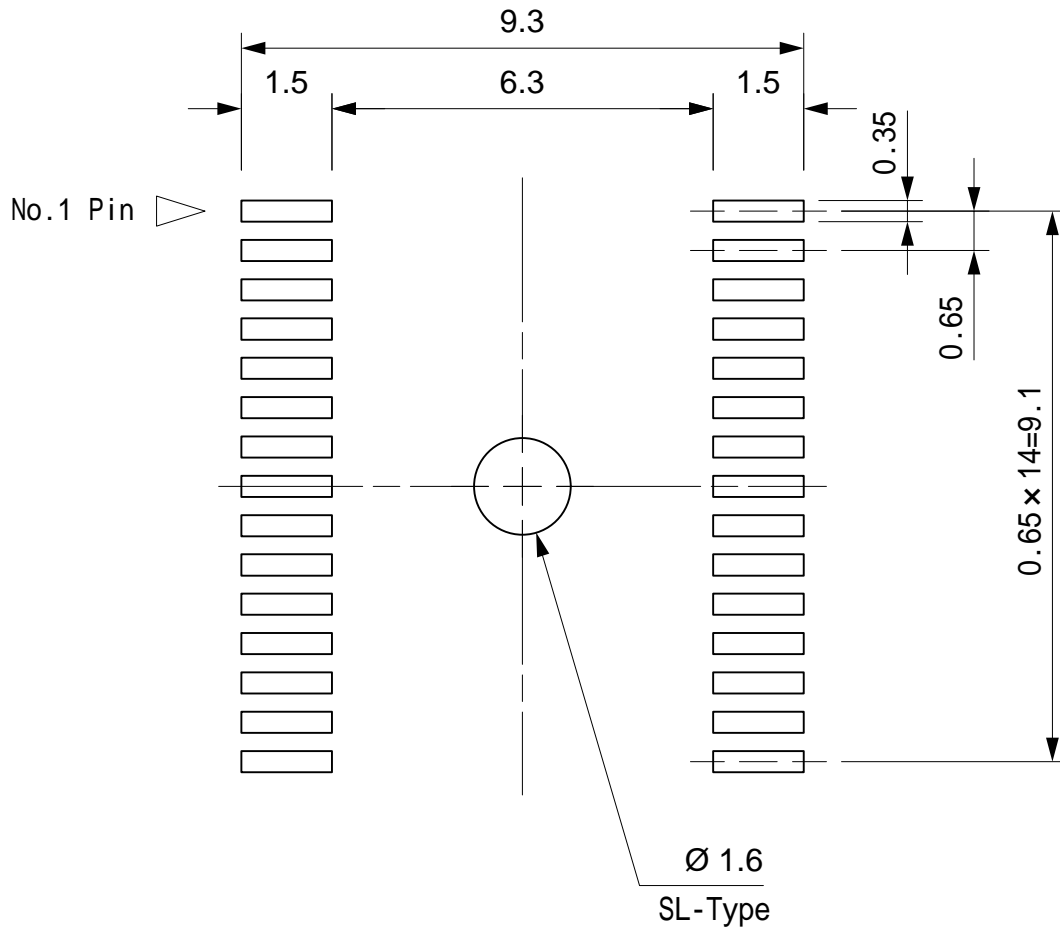


## Recommended a Footpattern of NSPACK30BK



\* Recommended foot pattern shown above is for NSPACK soldering.  
But please refer to IC package foot pattern recommended by IC manufacturer  
also, when the package is soldered on the same foot pattern .

Part No.	<b>NSPACK30BK</b>	
IC package	SSOP	
Pin count	30 Pin	
Lead pitch	0.65 mm	
Unit : mm	Design : M.M	
<b>TET</b> TOKYO ELETECH CORP.		